

Chemistry and Materials Engineering for Industry

A Professional Networking Event

Sponsored By:



What:

ACS Detroit, BASF, Wayne State, and the University of Toledo have teamed up to bring together industrial and academic chemists/engineers for networking, learning, and collaboration. There will be two guest lectures and a poster session. Please join us at the Federal Reserve Bank in Detroit for drinks and hors d'oeuvres! Space is limited so please RSVP by November 15th. The event is free, but you must RSVP to attend.

When:

Friday, December 6th, 2 – 6 PM

Where:

Federal Reserve Bank of Chicago
1600 E Warren Ave, Detroit, MI 48207

Registration and Federal-issued ID **required** to attend

RSVP by November 15th:

Raymond.Neff@basf.com or Jacob.Brutman@basf.com